## STD13005

## High voltage fast-switching NPN power transistor

Preliminary data

#### **Features**

- High voltage capability
- Low spread of dynamic parameters
- Very high switching speed

#### **Application**

Switch mode power supplies (AC-DC converters)

#### **Description**

The device is manufactured using high voltage multi-epitaxial planar technology for high switching speeds and high voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

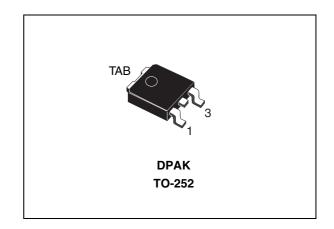


Figure 1. Internal schematic diagram

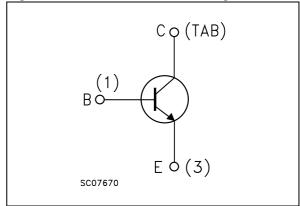


Table 1. Device summary

Order code	Marking	Package	Packaging
STD13005T4	D13005	DPAK	Tape and reel

November 2009 Doc ID 16780 Rev 1 1/10

Electrical ratings STD13005

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>BE</sub> = 0)	700	V
V <sub>CEO</sub>	Collector-emitter voltage (I <sub>B</sub> = 0)	400	V
V <sub>EBO</sub>	Emitter-base voltage ( $I_C = 0$ ; $I_B = 1.5 \text{ A}$ ; $t_p < 10 \text{ ms}$ )	V <sub>(BR)EBO</sub>	V
I <sub>C</sub>	Collector current	3	Α
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5 ms)	6	Α
I <sub>B</sub>	Base current	1.5	Α
I <sub>BM</sub>	Base peak current (t <sub>P</sub> < 5 ms)	3	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	30	W
T <sub>STG</sub>	Storage temperature	-65 to 150	°C
T <sub>J</sub>	Max. operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit	
R <sub>thJC</sub>	Thermal resistance junction-case max		4.2	°C/W

## 2 Electrical characteristics

 $T_{case}$  = 25 °C unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V T <sub>C</sub> = 125 °C			1 5	mA mA
I <sub>CEO</sub>	Collector-cut-off current (I <sub>B</sub> = 0)	V <sub>CE</sub> = 400 V			1	mA
V <sub>(BR)EBO</sub>	Emitter base breakdown voltage $(I_C = 0)$	I <sub>E</sub> = 10 mA	9		18	V
V <sub>CEO(sus)</sub> (1)	Collector-emitter sustaining voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 10 mA	400			V
V <sub>CE(sat)</sub> (1)	Collector-emitter saturation voltage	$\begin{split} I_C &= 1 \text{A} & I_B = 200 \text{ mA} \\ I_C &= 2 \text{A} & I_B = 500 \text{ mA} \\ I_C &= 3 \text{A} & I_B = 750 \text{ mA} \end{split}$			0.5 0.6 5	V V V
V <sub>BE(sat)</sub> (1)	Base-emitter saturation voltage	$I_C = 1A$ $I_B = 200 \text{ mA}$ $I_C = 2A$ $I_B = 500 \text{ mA}$			1.2 1.6	V V
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	$\begin{split} I_{C} &= 500 \; \mu A & V_{CE} &= 2 \; V \\ I_{C} &= 425 \; mA & V_{CE} &= 2 \; V \\ I_{C} &= 1 \; A & V_{CE} &= 5 \; V \\ I_{C} &= 2 \; A & V_{CE} &= 5 \; V \end{split}$	15 24 10 8		30 24	
t <sub>s</sub>	Resistive load Storage time Fall time	$I_C = 2 A$ $V_{CC} = 125 V$ $I_{B1} = -I_{B2} = 400 \text{ mA}$ $I_p = 30  \mu\text{s}$		1.65 260		μs ns
t <sub>s</sub>	Inductive load Storage time Fall time	$\begin{split} I_{C} &= 1 \text{ A} & V_{clamp} = 300 \text{ V} \\ I_{B1} &= 200 \text{ mA } V_{BE(off)} = -5 \text{ V} \\ L &= 50 \text{ mH} & R_{BB} = 0 \end{split}$		0.8 150		μs ns

<sup>1.</sup> Pulse test: pulse duration  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %

Electrical characteristics STD13005

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

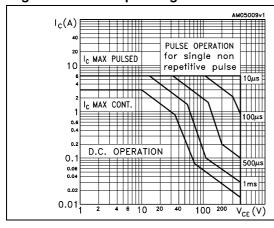


Figure 3. Derating curve

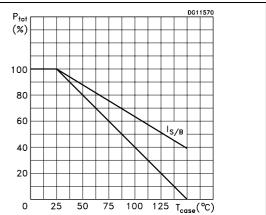


Figure 4. Reverse biased SOA

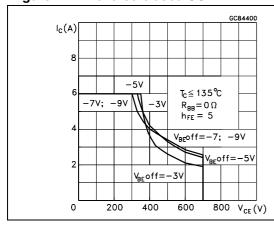


Figure 5. Output characteristics

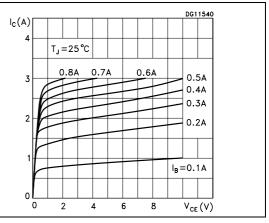


Figure 6. DC current gain  $(V_{CE} = 1 V)$ 

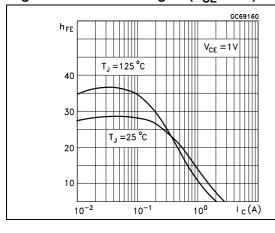
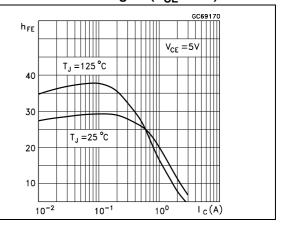


Figure 7. DC current gain  $(V_{CE} = 5 V)$ 



 $I_{c}(A)$ 

Figure 8. Collector-emitter saturation voltage Figure 9. **Base-emitter saturation voltage** 

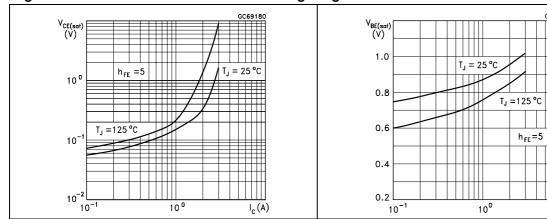


Figure 10. Inductive load fall time

Figure 11. Inductive load storage time

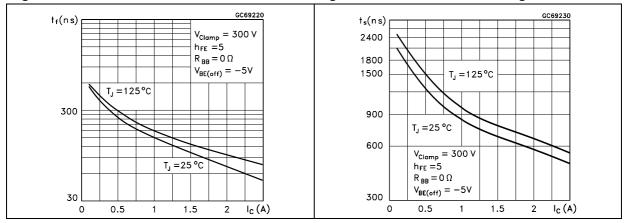


Figure 12. Resistive load fall time

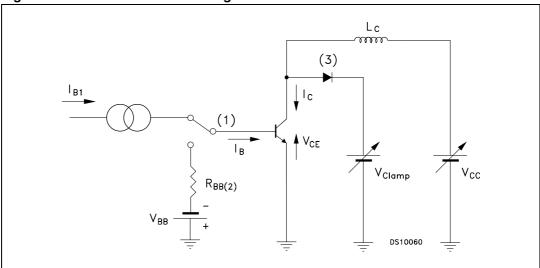
Figure 13. Resistive load storage time  $t_f(ns)$  $t_s(ns)$ V<sub>CC</sub> = 125 V 800  $h_{FE} = 5$  $I_{B1} = -I_{B2}$ 600 500  $T_J = 125$  °C 400 T<sub>J</sub> = 125 °C

 $I_{C}(A)$ 

Test circuits STD13005

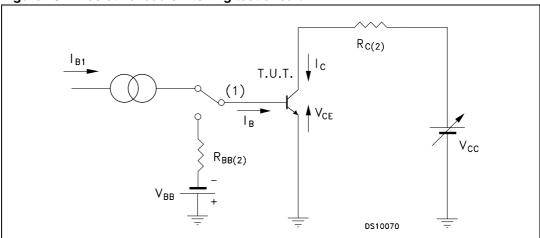
## 3 Test circuits

Figure 14. Inductive load switching test circuit



- 1) Fast electronic switch
- 2) Non-inductive resistor
- 3) Fast recovery rectifier

Figure 15. Resistive load switching test circuit



Doc ID 16780 Rev 1

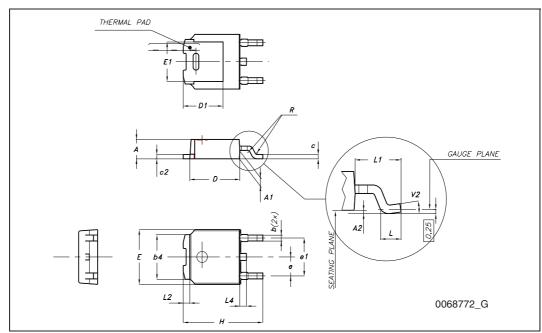
- 1) Fast electronic switch
- 2) Non-inductive resistor

## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

TO-252 (DPAK) mec	hanical	data
-------------------	---------	------

DIM.	mm.			
DIIVI.	min.	typ	max.	
А	2.20		2.40	
A1	0.90		1.10	
A2	0.03		0.23	
b	0.64		0.90	
b4	5.20		5.40	
С	0.45		0.60	
c2	0.48		0.60	
D	6.00		6.20	
D1		5.10		
E	6.40		6.60	
E1		4.70		
е		2.28		
e1	4.40		4.60	
Н	9.35		10.10	
L	1			
L1		2.80		
L2		0.80		
L4	0.60		1	
R		0.20		
V2	0 °		8 °	



Doc ID 16780 Rev 1

STD13005 Revision history

# 5 Revision history

Table 5. Document revision history

Date	Revision	Changes
12-Nov-2009	1	First release.

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2009 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

10/10 Doc ID 16780 Rev 1

